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Общество с ограниченной ответственностью

«Научно-производственное предприятие «Техно-ПАРК»

(ООО «НПП «Техно-ПАРК»)

Юридический и фактический адрес: 121351, г. Москва,

ул. Ивана Франко, д. 48

Технические характеристики генератора TG1612SLN

Производитель: Epson

Поставщик: ООО «НПП «Техно-ПАРК»

Научно-производственное предприятие ООО «НПП «Техно-ПАРК» разрабатывает и поставляет полосно-пропускающие радиочастотные фильтры на поверхностных акустических волнах (ПАВ) и устройства на их основе.

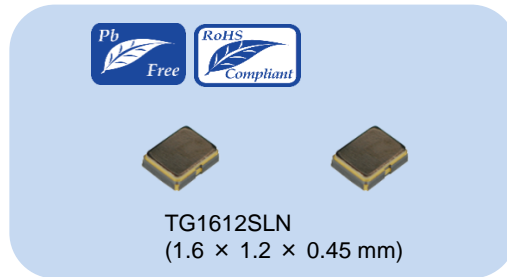
E-mail: mail@sawtechno.ru **Web:** www.sawtechno.ru

+105 °C & Standby compatible temperature compensated crystal oscillator (TCXO)

Product name : TG1612SLN

Features

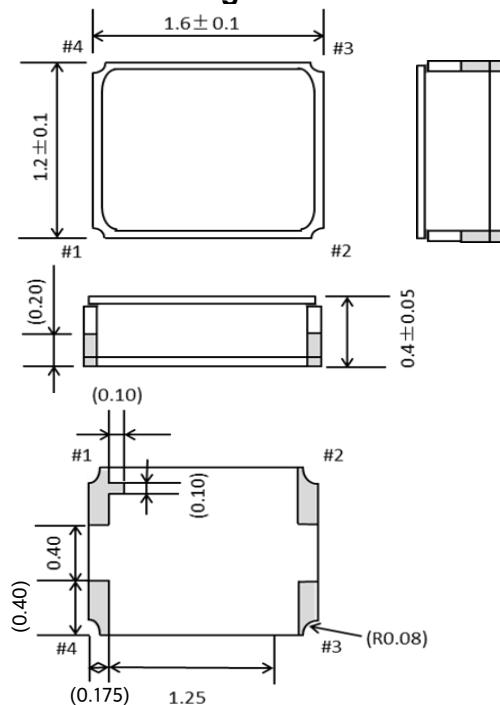
- External dimensions: 1.6 × 1.2 × 0.45 mm Max.
- Frequency range: 13 MHz to 55.2 MHz
- Output: Clipped Sine Wave
- Supply voltage: 1.7 V to 3.63 V
- Operating temperature: -40 °C to +105 °C
- Frequency / temperature characteristic
 : $\pm 0.5 \times 10^{-6}$ Max. (-40 °C to +85 °C)
 : $\pm 5.0 \times 10^{-6}$ Max. (-40 °C to +105 °C)
- Function: TCXO-Standby, VC-TCXO, TCXO



Applications

- GNSS, Smart phone
- Wireless communication devise
- LPWA, LTE, WiMAX, Wi-Fi, W-LAN
- IoT etc..

Outline Drawing



Terminal Assignment

Pin #	Connection
1	N.C. (TCXO)
	V _c (VC-TCXO)
	ST (Standby)
2	GND
3	OUT
4	V _{CC}

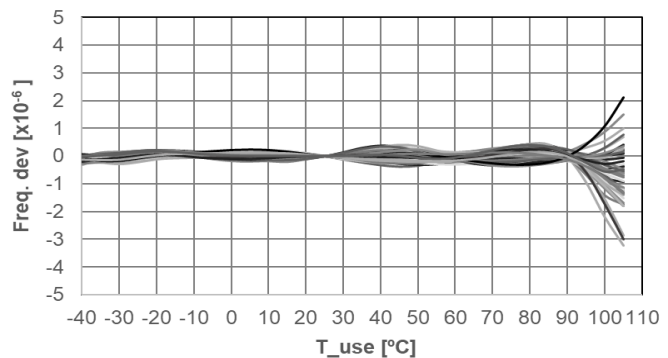
Description

TG1612SLN support 105 °C and standby function utilizing an Epson-developed and fabricated IC and MHz fundamental crystal .

Combined with the single seal structural advantage of tiny size, low height (0.45 mm Max.) and pressure & molding sealing resistance, the SLN series is ideal for IoT and industrial applications.

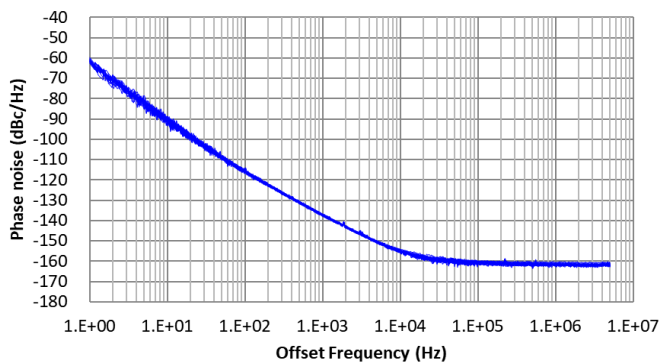
Typical Performance

Frequency / Temperature Characteristics
26 MHz



Phase Noise Characteristics

26 MHz



[1] Product Number / Product Name

(1-1) Product Number

X1G005721xxxx16 (Please contact Epson for details, please also check [12] Packing information)

(1-2) Product Name (Standard Form)

TG1612 SLN 26.000000MHz E W H S N M

① ② ③ ④⑤⑥⑦⑧⑨

①Model (TG1612xLN) ②Output (S: Clipped sine wave) ③Frequency

④Supply voltage (Refer to symbol table)

⑤Frequency / temperature characteristics (C: $\pm 0.5 \times 10^{-6}$ Max., F: $\pm 2.0 \times 10^{-6}$ Max., W: $\pm 0.5 \times 10^{-6}$ Max. and $\pm 5.0 \times 10^{-6}$ Max.)

⑥Operating temperature (H: -40 °C to +105 °C, G: -40 °C to +85 °C) ⑦Standby function (N: Non, S: Standby)

⑧VC function (Refer to symbol table, N: Non for TCXO, Standby mode) ⑨Internal identification code ("M" is default)

Symbol table	Suffix symbol: Voltage(Typ.) [V]			
④V _{CC} : Common	E: 1.8	B: 2.8	A: 3.0	C: 3.3
⑧V _C : VC-TCXO Only	B: 0.9	C: 1.4	D: 1.5	E: 1.65

(2) Product Number / Ordering Code [Please refer to the web site for the latest information](#)

Frequency	Part number	
[MHz]	$\pm 0.5 \times 10^{-6}$ (-40 °C to +85 °C), $\pm 5.0 \times 10^{-6}$ (+85 °C to +105 °C)	
	Standby function	
	V _{CC} = 1.8 V Suffix: EWHSNM	V _{CC} = 3.3 V Suffix: CWHSNM
26	X1G005721070116	X1G005721080116

[2] Absolute Maximum Ratings

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Supply voltage	V _{CC-GND}	-0.5	-	+4.0	V	
Frequency control voltage	V _{C-GND}	-0.3	-	V _{CC} + 0.3	V	V _C Terminal
Input voltage	V _{IN}	-0.3	-	V _{CC} + 0.3	V	\overline{ST} Terminal
Storage temperature range	T _{stg}	-40	-	+105	°C	Storage as single product

[3] Recommended Operating Conditions

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Supply voltage	V _{CC}	1.7	1.8	1.9	V	E: V _{CC} = 1.8 V \pm 0.1 V B: V _{CC} = 2.8 V \pm 5 % A: V _{CC} = 3.0 V \pm 5 % C: V _{CC} = 3.3 V \pm 5 %
		-5 %	2.8	+5 %	V	
		-5 %	3.0	+5 %	V	
		-5 %	3.3	+5 %	V	
Supply voltage	GND	0	-	0	V	
Frequency control voltage	V _C	GND	N.C	-	V	N: TCXO B: V _C = 0.9 \pm 0.6 V C: V _C = 1.4 \pm 1.0 V D: V _C = 1.5 \pm 1.0 V E: V _C = 1.65 \pm 1.0 V
		0.3	0.9	1.5	V	
		0.4	1.4	2.4	V	
		0.5	1.5	2.5	V	
		0.65	1.65	2.65	V	
Operating temperature range	T _{use}	-40	+25	+85	°C	Standard
		-40	+25	+105	°C	Option
Output load	Load _R	9	10	11	k Ω	DC-cut capacitor *
	Load _C	9	10	11	pF	
	C _c	0.01	-	-	μ F	

* DC-cut capacitor is not included in this TCXO. Please attach an external DC-cut capacitor to the out pin.

[4] Frequency Characteristics

(4-1) Frequency Characteristics

(V_{CC} = Typ., V_c = Typ., Output load = 10 kΩ // 10 pF, T_{use} = +25 °C)

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Output Frequency	f _o	13	-	55.2	MHz	Standard Frequency
		26				
Frequency tolerance	f _{tol}	-1.0	-	+1.0	x10 ⁻⁶	T _{use} = +25 °C ± 2 °C Before reflow
Frequency tolerance *1	f _{tol}	-2.0	-	+2.0	x10 ⁻⁶	T _{use} = +25 °C ± 2 °C After 3 reflows *2
Frequency / temperature characteristics	fo-Tc	-0.5	-	+0.5	x10 ⁻⁶	T _{use} = -40 °C to +85 °C (Reference to +25 °C)
		-5.0	-	+5.0	x10 ⁻⁶	Option T _{use} = +85 °C to +105 °C (Reference to +25 °C)
Frequency / load coefficient	fo-Load	-0.1	-	+0.1	x10 ⁻⁶	Load ± 10 %
Frequency / voltage coefficient	fo-V _{CC}	-0.2	-	+0.2	x10 ⁻⁶	V _{CC} ± 5 % *3
Frequency aging_1year *4	f _{age_1y}	-1.0	-	+1.0	x10 ⁻⁶	13 MHz ≤ f _o ≤ 20 MHz, 26 MHz ≤ f _o ≤ 40 MHz
Frequency aging_3year	f _{age_3y}	-2.0	-	+2.0	x10 ⁻⁶	
Frequency aging_5year	f _{age_5y}	-3.0	-	+3.0	x10 ⁻⁶	
Frequency aging_10year	f _{age_10y}	-4.0	-	+4.0	x10 ⁻⁶	
Frequency aging_1year *4	f _{age_1y}	-1.5	-	+1.5	x10 ⁻⁶	20 MHz < f _o < 26 MHz, 40 MHz < f _o ≤ 55.2 MHz
Frequency aging_3year	f _{age_3y}	-2.5	-	+2.5	x10 ⁻⁶	
Frequency aging_5year	f _{age_5y}	-4.0	-	+4.0	x10 ⁻⁶	
Frequency aging_10year	f _{age_10y}	-5.0	-	+5.0	x10 ⁻⁶	
Acceleration sensitivity	-	-	-	1.5	x10 ⁻⁹ /g	3 axes, 30 Hz to 3000 Hz

*1 Include initial frequency tolerance and frequency deviation after reflow cycles.

*2 Measured in the elapse of 24 hours after reflow soldering.

*3 V_{CC} ± 0.1 V when V_{CC} = 1.8 V

*4 Aging stability is estimated from environmental reliability tests; expected amount of the frequency variation.

(4-2) Frequency Control Characteristics (VC-TCXO Only)

(V_{CC} = Typ., V_c = Typ., Output load = 10 kΩ // 10 pF, T_{use} = +25 °C)

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Frequency control range	f _{cont}	-15.0	-	-8.0	x10 ⁻⁶	B: V _c = 0.9 V - 0.6 V at V _{CC} = 1.8 V C: V _c = 1.4 V - 1.0 V at V _{CC} = 2.8 V D: V _c = 1.5 V - 1.0 V at V _{CC} = 3.0 V E: V _c = 1.65 V - 1.0 V at V _{CC} = 3.3 V
		+8.0	-	+15.0	x10 ⁻⁶	B: V _c = 0.9 V + 0.6 V at V _{CC} = 1.8 V C: V _c = 1.4 V + 1.0 V at V _{CC} = 2.8 V D: V _c = 1.5 V + 1.0 V at V _{CC} = 3.0 V E: V _c = 1.65 V + 1.0 V at V _{CC} = 3.3 V
Input impedance	Z _{in}	500	-	-	kΩ	V _c -GND(DC)
Frequency change polarity	-	Positive polarity			-	

[5] Electrical Characteristics

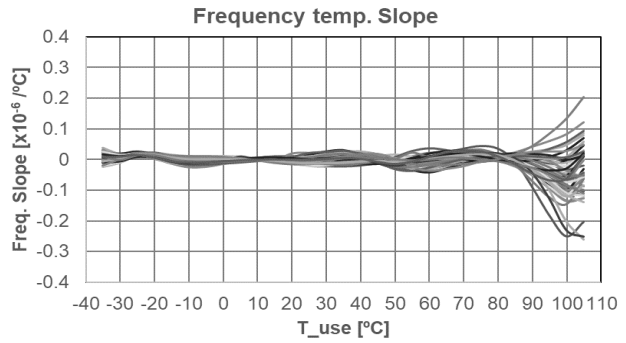
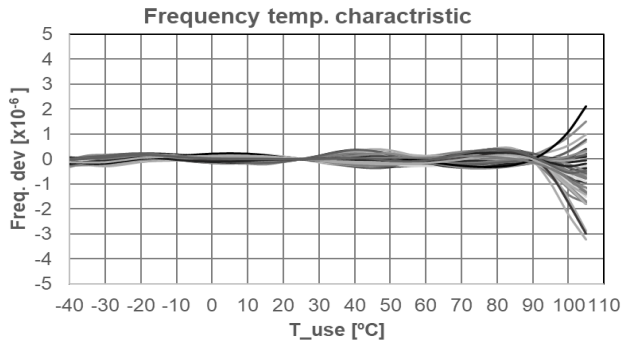
(V_{CC} = Typ., V_c = Typ., Output load = 10 kΩ // 10 pF, T_{use} = +25 °C)

Parameter	Symbol	Specifications			Unit	Conditions
		Min.	Typ.	Max.		
Current consumption	I _{CC}	-	-	1.5	mA	13 MHz ≤ f _o ≤ 26 MHz, -40 to +85 °C
		-	-	1.7	mA	13 MHz ≤ f _o ≤ 26 MHz, -40 to +105 °C
		-	-	2.0	mA	26 MHz < f _o ≤ 38.4 MHz, -40 to +105 °C
		-	-	2.5	mA	38.4 MHz < f _o ≤ 55.2 MHz, -40 to +105 °C
Output voltage	V _{pp}	0.8	-	1.5	V _{p-p}	Peak to peak voltage
Start-up time	t _{str}	-	-	1.0	ms	Until output signal has been reached min 90 % of final amp -40 °C to +105 °C
		-	-	2.0	ms	Until frequency has been reached within ±0.5 × 10 ⁻⁶ , -40 °C to +85 °C within ±5.0 × 10 ⁻⁶ , +85 °C to +105 °C
Symmetry	SYM	45	50	55	%	GND level (DC-cut)
Harmonics	H _m	-	-	-10.0	dBc	
Phase noise f _o = 26 MHz	L(f)	-	-61	-	dBc/Hz	1 Hz offset
		-	-90	-		10 Hz offset
		-	-115	-		100 Hz offset
		-	-137	-		1 kHz offset
		-	-155	-		10 kHz offset
		-	-160	-		100 kHz offset
		-	-161	-		1 MHz offset
Stand-by current	I _{std}	-	-	3	μA	\overline{ST} = GND
Input voltage	V _{IH}	80 % V _{CC}	-	-	V	\overline{ST} terminal
Input voltage	V _{IL}	-	-	20 % V _{CC}	V	\overline{ST} terminal
Output disable time (ST)	t _{stp_st}	-	-	150	ns	\overline{ST} terminal: High to Low
Output enable time (ST)	t _{sta_st}	-	-	2	ms	\overline{ST} terminal: Low to High

[6] Characteristic Data

(6-1) Frequency / Temperature Characteristics & Frequency Slope

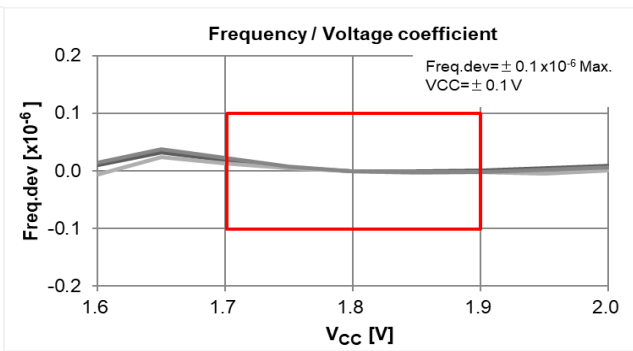
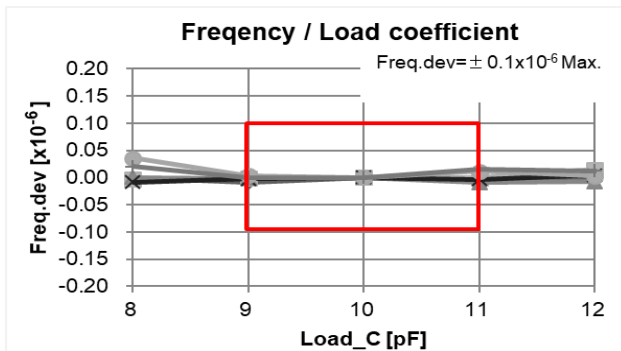
26 MHz (n = 50 pcs)



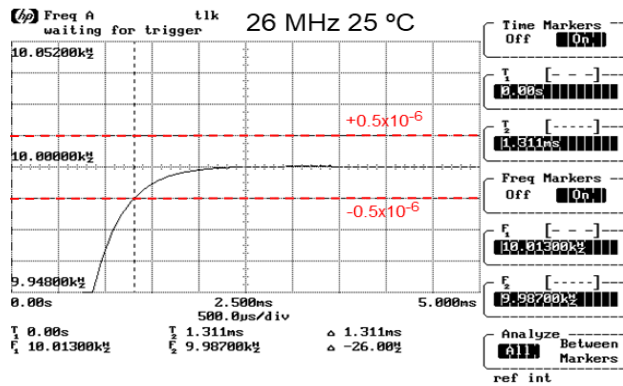
(6-2) Frequency / Load Coefficient & Frequency / Voltage Coefficient

26 MHz (V_{CC} = 1.7 V, 3.63 V, T_{use} = 25 °C, n = 3 pcs)

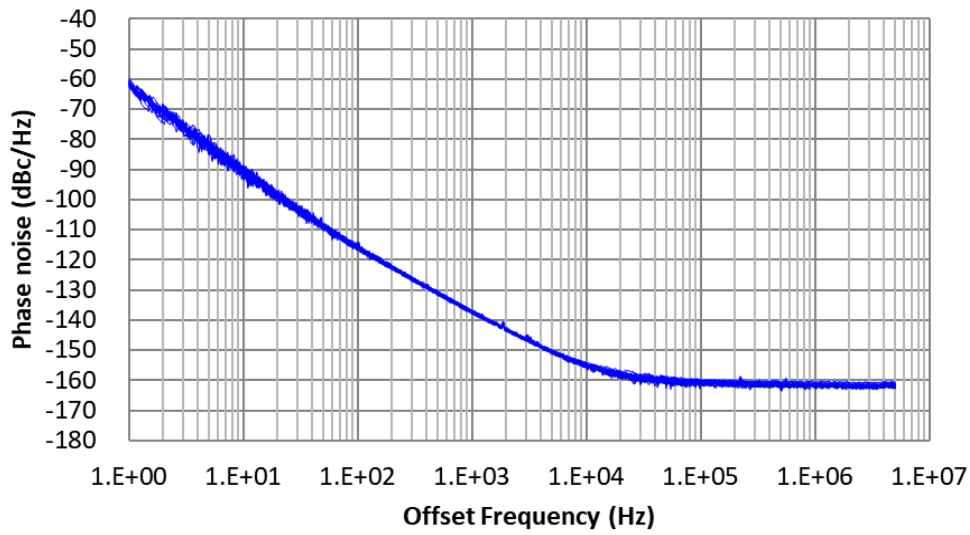
26 MHz (V_{CC} = 1.8 V center, T_{use} = 25 °C, n = 3 pcs)



(6-3) Start-up time (T_{use} = 25 °C, X axis Scale = 0.5 ms/div, Y axis Scale = 0.5 x 10⁻⁶ /div)



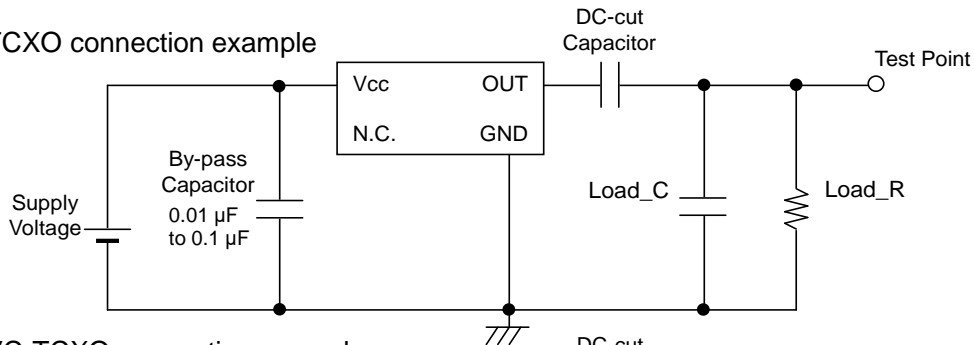
(6-4) Phase Noise

(1) $f_o = 26 \text{ MHz}$, $V_{CC} = 1.8 \text{ V}$, $T_{\text{use}} = +25 \text{ }^\circ\text{C}$, $n = 20 \text{ pcs}$ 

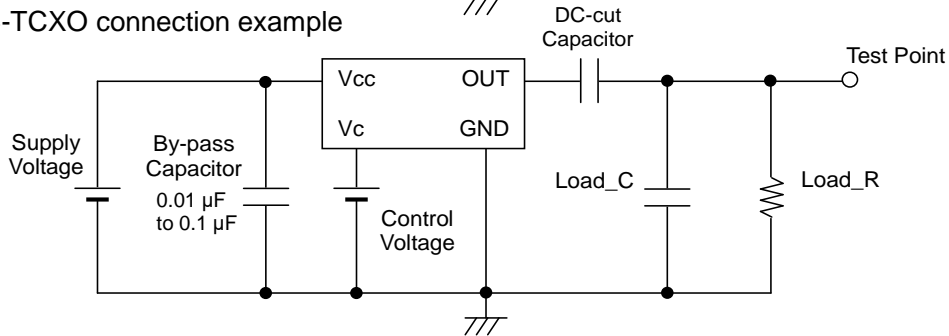
[7] Test circuit

(7-1) Output load = 10 kΩ // 10 pF

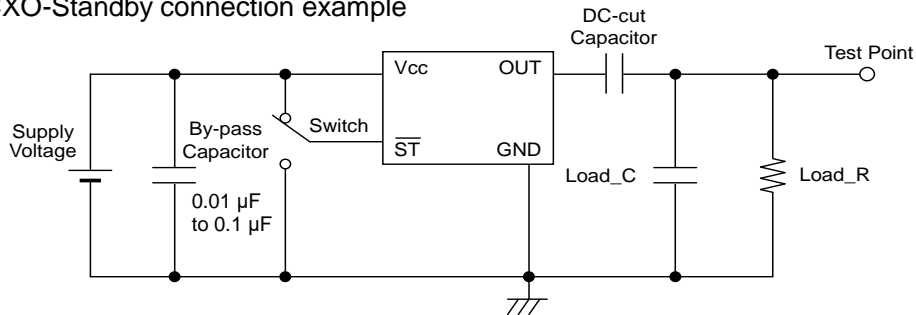
(1)TCXO connection example



(2)VC-TCXO connection example

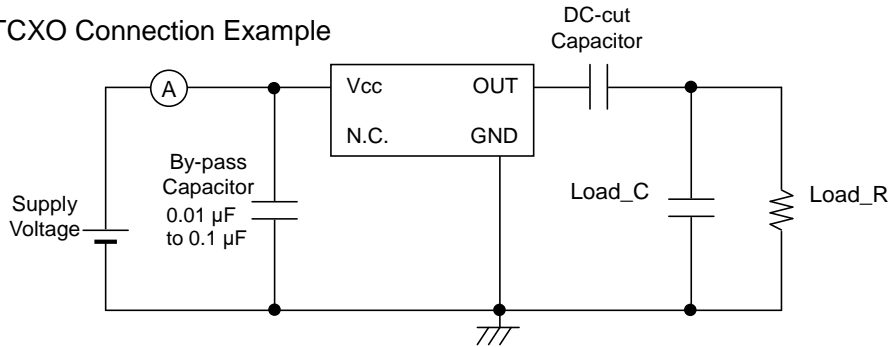


(3)TCXO-Standby connection example

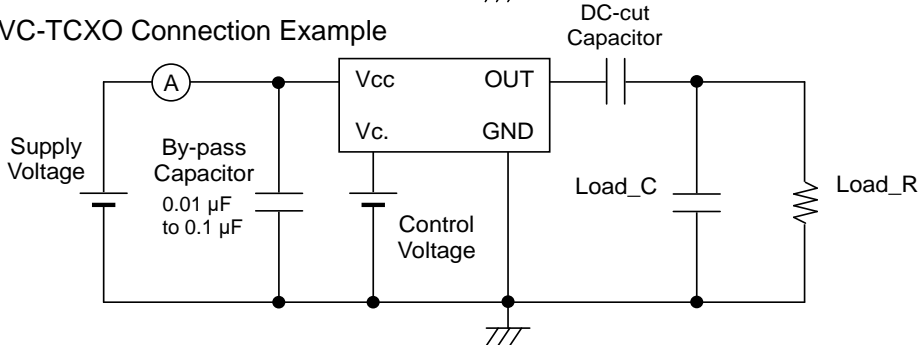


(7-2) Current Consumption

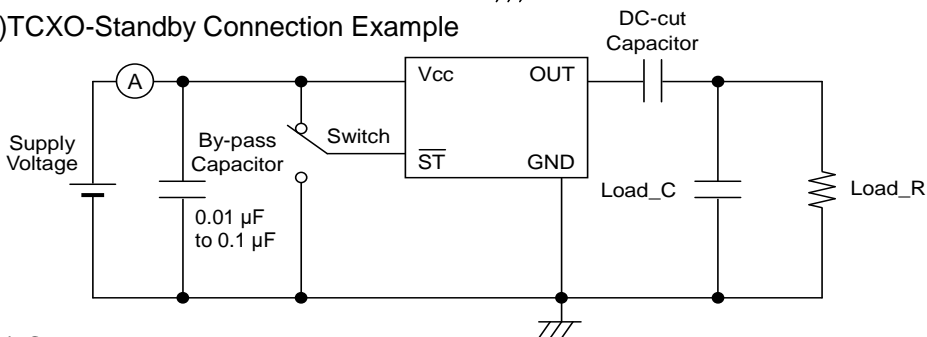
(1)TCXO Connection Example



(2)VC-TCXO Connection Example



(3)TCXO-Standby Connection Example



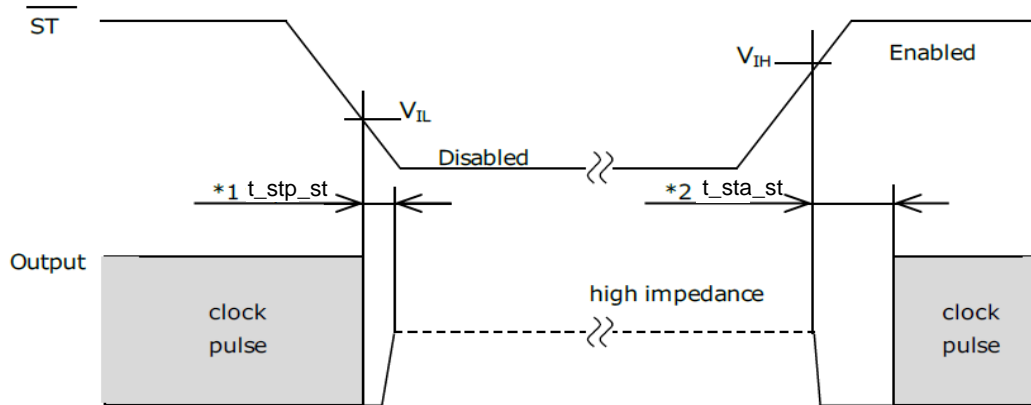
(7-3) Conditions

1. Oscilloscope: Impedance Min. 1 M Ω
Input capacitance Max. 10 pF
Band width Min. 300 MHz
Impossible to measure both frequency and wave form at the same time.
(In case of using oscilloscope's amplifier output, possible to measure both at the same time.)
2. Load_C includes probe capacitance.
3. A capacitor (By-pass: 0.01 μ F to 0.1 μ F) should be placed between V_{CC} and GND, and closely to TCXO.
4. Use the current meter with a low internal impedance.
5. Power Supply
• Impedance of power supply should be as low as possible.
6. GND pin should be connected to low impedance GND.

(7-4) Timing Chart

(1) Standby Function and Timing

Standby input	Osc. Circuit	Output status
High or OPEN	Oscillation	Specified frequency output: Enable
Low	Stop	Output becomes high impedance: Disable



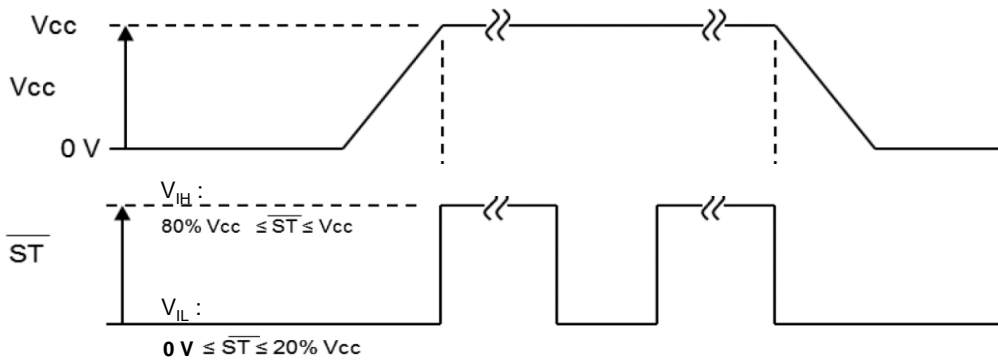
*1 t_{stp_st} : The time from $\overline{ST} = V_{IL}$ to output = disable (high impedance)

*2 t_{sta_st} : The time from $\overline{ST} = V_{IH}$ to starting output

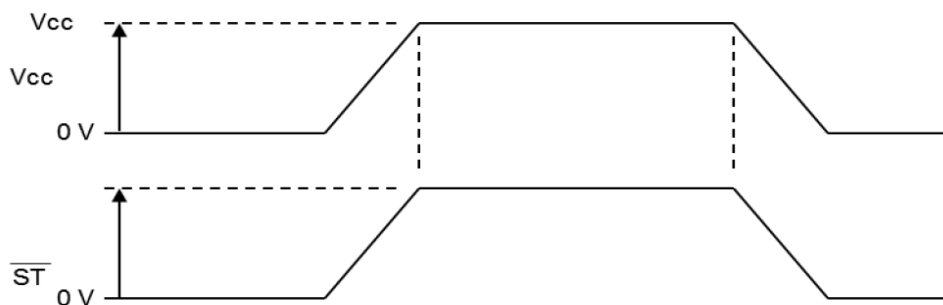
(2) Standby Control Timing

Standby control voltage must be in the range of V_{IN} ([2] Absolute maximum rating), V_{IH} , V_{IL} ([5] Electrical characteristics).

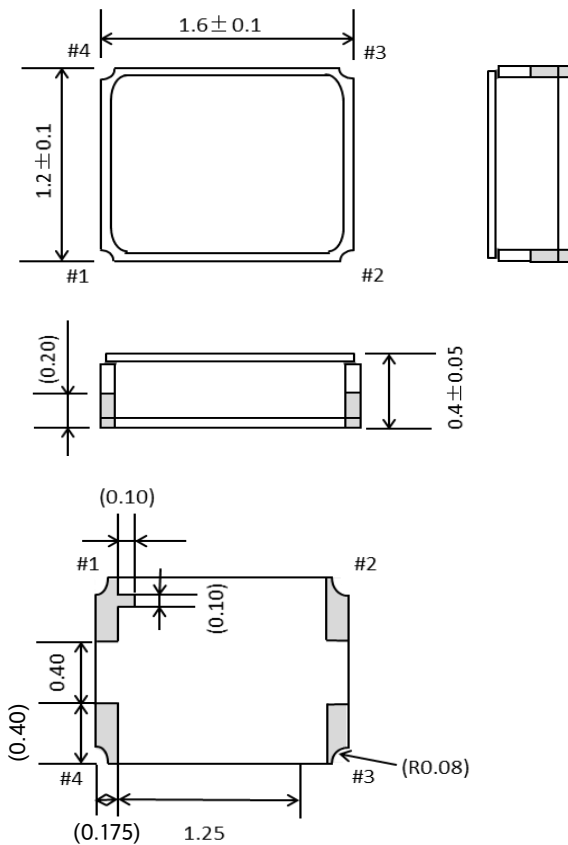
When standby control and V_{CC} control are different



When standby control and V_{CC} control are the same

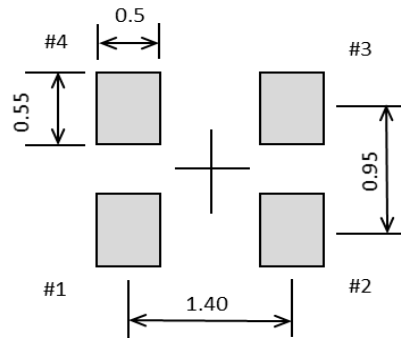


[8] Outline Drawing unit: mm



Terminal coating: Au plating
Reference weight Typ.: 3.0 mg

Recommended Foot Print unit: mm



Pin #	Connection
1	N.C. (TCXO)
	Vc (VC-TCXO)
	\overline{ST} (Standby)
2	GND
3	OUT
4	V _{CC}

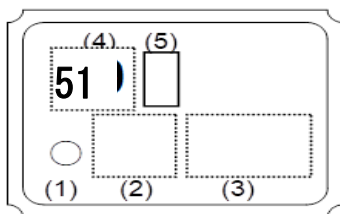
Please keep "N.C." pin OPEN condition or GND connection.

"N.C." pin doesn't work as a ground pin.

For stable operation, please add a bypass capacitor ($0.01 \mu\text{F}$ to $0.1 \mu\text{F}$) between V_{CC} and GND. Please place it as close to TCXO as possible.

Please do not place any pattern between footprint pads.

[9] Marking



- (1) 1 Pin Mark
- (2) Arbitrary marking area (2 digits)
- (3) TCXO Lot No. (3 digits)
- (4) TCXO model ID ("x" means turn number)
- (5) Image recognition mark

[10] Moisture Sensitivity Level , Electro-Static Discharge

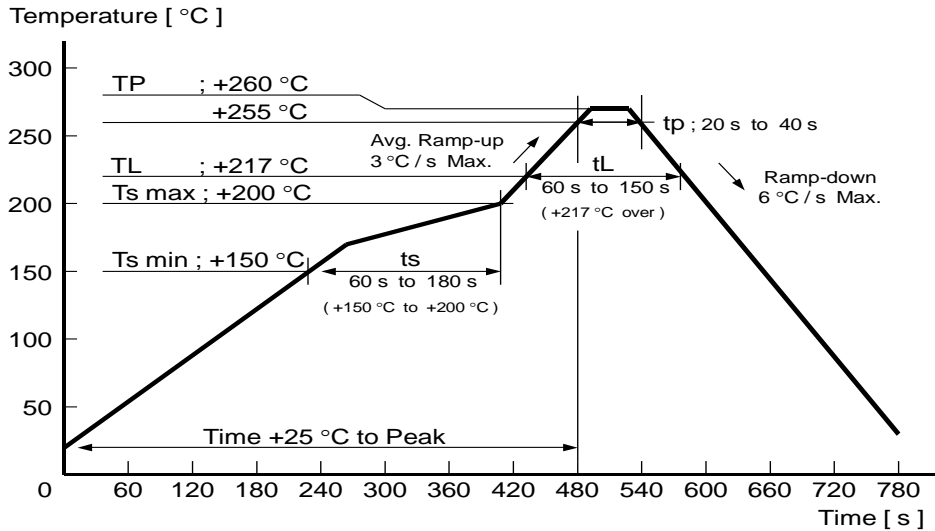
(1) Moisture Sensitivity Level (MSL)

Parameter	Specifications	Conditions
MSL	LEVEL1	JEDEC J-STD-020D

(2) Electro-Static Discharge (ESD)

Parameter	Specifications	Conditions
Human Body Model (HBM)	2 000 V Min.	IEC 60749-26 Ed.2.0:2006(b) 100 pF, 1.5 kΩ, 3 times
Machine Model (MM)	200 V Min.	IEC 60749-26 Ed.2.0:2006(b) 200 pF, 0 Ω, 1 time

[11] Reflow Profile (follow to IPC / JEDEC J-STD-020D.1)



[12] Packing Information

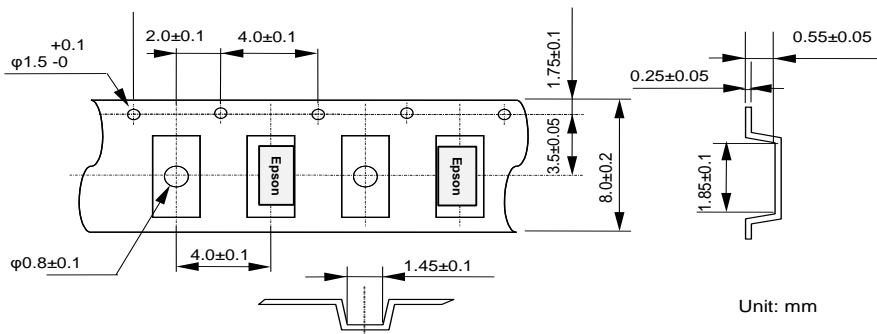
(12-1) Product number last 2 digits code(16) define Quantity. The standard is "16", 3 000 pcs/Reel.
X1G005721xxxx16

(12-2) Taping Specification Subject to EIA-481A & EIAJ RC-1009B

(1) Tape Dimensions TE0804L

Material of the Carrier Tape : PS / Material of the Top Tape : PET+PE

unit: mm



Unit: mm

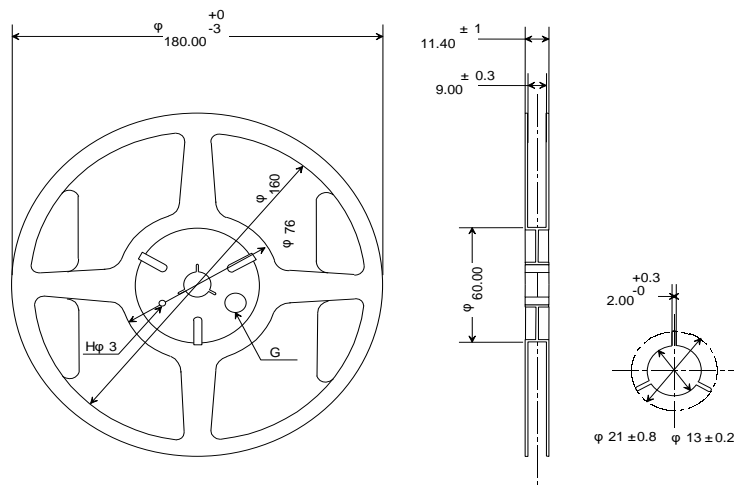
PS (Polystyrene), PET (Polyethylene Terephthalate), PE (Polyethylene)

(2) Reel Dimensions

Center material : PS

Material of the Reel : PS

PS (Polystyrene)



[13] Handling Precautions

Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (<https://www5.epsondevice.com/en/information/#precaution>) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.

Before using the product under any conditions other than those specified therein, please consult with us to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

- (1) Do not expose this product to excessive mechanical shock or vibration.
- (2) This product can be damaged by mechanical shock during the soldering process depending on the equipment used, process conditions, and any impact forces experienced. Always follow appropriate procedures, particularly when changing the assembly process in anyway and be sure to follow applicable process qualification standards before starting production.
- (3) These devices are sensitive to ESD, please use appropriate precautions during handling, assembly, test, shipment, and installation.
- (4) This product contains semiconductor content that should not be exposed to electromagnetic waves.
- (5) The use of ultrasonic technology for cleaning, bonding, etc. can damage the Xtal unit inside this product. Please carefully check for this consideration before using ultrasonic equipment for volume production with this product.
- (6) Noise and ripple on the power supply may have undesirable affects on operation and cause degradation of phase noise characteristics. Evaluate the operation of this device with appropriate power supplies carefully before use.
- (7) When applying power, ensure that the supply voltage increases monotonically for proper operation. On power down, do not reapply power until the supplies, bypass capacitors, and any bulk capacitors are completely discharged since that may cause the unit to malfunction.
- (8) Aging specifications are estimated from environmental reliability tests and expected frequency variation over time. They do not provide a guarantee of aging over the product lifecycle.
- (9) The metal cap on top of the device is directly connected to the GND terminal (pin #2). Take necessary precautions to prevent any conductor not at ground potential from contacting the cap as that could cause a short circuit to GND.
- (10) Do not route any signal lines, supply voltage lines, or GND lines underneath the area where the oscillators are mounted including any internal layers and on the opposite side of the PCB.
To avoid any issues due to interference of other signal lines, please take care not to place signal lines near the product as this may have an adverse affect on the performance of the product.
- (11) A bypass capacitor of the recommended value(s) must be connected between the V_{CC} and GND terminals of the product. Whenever possible, mount the capacitor(s) on the same side of the PCB and as close to the product as possible to keep the routing traces short.
- (12) Power supply connections to V_{CC} and GND pins should be routed as thick as possible while keeping the high frequency impedance low in order to get the best performance.
- (13) The use of a filter or similar element in series with the power supply connections to protect from electromagnetic radiation noise may increase the high frequency impedance of the power supply line and may cause the oscillator to not operate properly. Please verify the design to ensure sufficient operational margin prior to use.
- (14) Keep PCB routing from the output terminal(s) to the load as short as possible for best performance.
- (15) Do not short the output to GND as that will damage the product. Always use with an appropriate load resistor connected.
- (16) Product failures during the warranty period only apply when the product is used according to the recommended operating conditions described in the specifications. Products that have been opened for analysis or damaged will not be covered. It is recommended to store and use in normal temperature and humidity environments described in the specifications to ensure frequency accuracy and prevent moisture condensation. If the product is stored for more than one year, please confirm the pin solderability prior to use.
- (17) If the oscillation circuit is exposed to condensation, the frequency may change or oscillation may stop. Do not use in any conditions where condensation occurs.
- (18) Do not store or use the product in an environment where it can be exposed to chemical substances that are corrosive to metal or plastics such as salt water, organic solvents, chemical gasses, etc. Do not use the product when it is exposed to sunlight, dust, corrosive gasses, or other materials for long periods of time.
- (19) When using water-soluble solder flux make sure to completely remove the flux residue after soldering. Pay particular attention when the residues contain active halogens which will negatively affect the product and its performance.
- (20) This product uses AuSn brazing material as the braze sealing material, due to this reflow soldering mounting is recommended. When removing the product from the PCB avoid excess heating of the sealing as excess heating to AuSn melting point (+278 °C) may deteriorate the characteristics of the device or reduce the hermetic sealing when soldering iron or an air disordering tool is used so use care to not expose the seal directly to the heat sources.

Should any customer use the product in any manner contrary to the precautions and/or advice herein, such use shall be done at the customer's own risk.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.



ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

■ Explanation of marks used in this datasheet

	<p>●Pb free.</p>
	<p>●Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other)</p>

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